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Editor-in-Chief

Professor K. H. J. Buschow
Van der Waals-Zeeman Laboratorium
Universiteit van Amsterdam
Valckenierstraat 65
1018 XE Amsterdam, Netherlands
Fax: +31 (20) 525 5788
e-mail: buschow@science.uva.nl

Editors

Professor H. Kleinke
Dept. of Chemistry
University of Waterloo
Waterloo, Ontario N2L 3G1
Canada
Tel.: +1 (519) 885 1211
Fax: +1 (519) 746 0435
e-mail: jalcom@uwaterloo.ca

Professor H.G. Pan

Department of Materials Science and
Engineering
Zhejiang University
Hangzhou 310029
P.R. China
Tel. & Fax: +86 (571) 87952615
e-mail: Honggepan@zju.edu.cn

Professor H. Sakaguchi

Department of Materials Science
Tottori University
Minami 4-101, Koyama-cho
Tottori 680-0945
Japan
Tel. & Fax: +81 (857) 31 5265
e-mail: sakaguch@chem.tottori-u.ac.jp

Professor L. Schultz

Leibniz -Institut fuer Festkoerper- und
Werkstofforschung (IFW) Dresden
Helmholtzstrasse
20D-01069 Dresden, Germany
Tel: +49-351-4659-100
Fax: +49-351-4659-500
e-mail: l.schultz@ifw-dresden.de

H. Zur Loye

Department of Chemistry/Biochemistry
University of South Carolina
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Fax: 803-777-8508
e-mail: JALCOM@chem.sc.edu

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Feng Chia University
40724 Taichung
Taiwan

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- review articles; authors should first consult one of the Editors
- letters
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